Qualcom

RF360 Europe GmbH

Data sheet

SAW duplexer

Series/type:	B8671
Ordering code:	B39851B8671P810
Date:	June 13, 2018
Version:	2.3

DCN: 80-PA243-212 Rev. A

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SAW duplexer B8671 Data sheet

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1 Application

- Low-loss SAW duplexer for mobile telephone LTE Band 20 systems
- High attenuation
- Low amplitude ripple
- Usable pass bands: 30 MHz
- Single-ended duplexer
- Very small size and low height

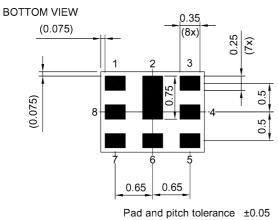
2 Features

- Package size 1.8±0.1 mm × 1.4±0.1 mm
- Package height 0.475 mm (max.)
- Approximate weight 5 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

SAW duplexer B8671 Data sheet

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3 Package



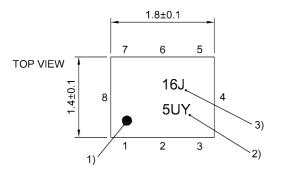
4 Pin configuration



- 6 ANT
- 2, 4, 5, 7, Ground 8

SIDE VIEW



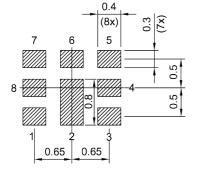


1) Marking for pad number 1

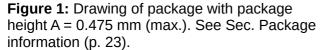
2) Example of encoded lot number

3) Example of encoded filter type number

Land pattern THRU VIEW

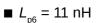


Landing pad tolerance -0.02



5 **Matching circuit**

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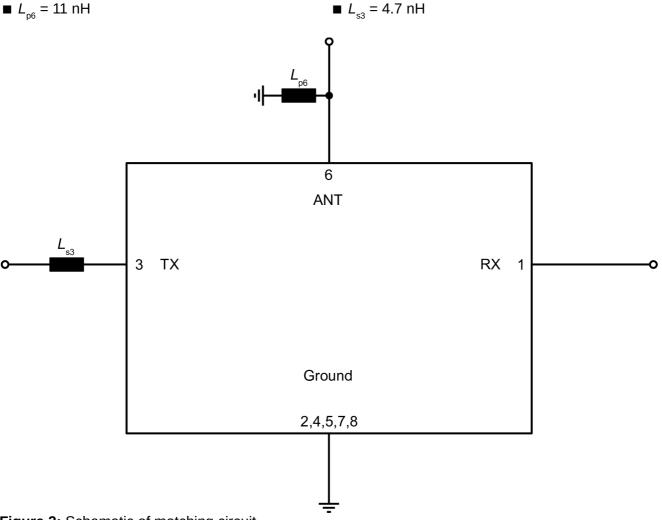


Figure 2: Schematic of matching circuit.

External shunt inductor for ESD protection is recommended at any ports towards antenna.

6 Characteristics

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6.1 TX – ANT

Temperature range for specification	$T_{\rm SPEC}$	= −20 °C +90 °C
TX terminating impedance	Z _{TX}	= 50 Ω with ser. 4.7 nH ¹⁾
ANT terminating impedance	Z	= 50 Ω with par. 11 nH ¹⁾
RX terminating impedance	Z _{RX}	= 50 Ω

Characteristics TX – ANT				$\begin{array}{c} {\rm min.} \\ {\rm for} \ {\rm T}_{\rm _{SPEC}} \end{array}$	typ. @ +25 °C	max. for $T_{\rm SPEC}$	
Center frequency			f _c	—	847		MHz
Maximum insertion attenuation			α_{max}				
	832.34 861.66	MHz		—	1.6	2.2	dB
Amplitude ripple (p-p)			Δα				
	832.34 861.66	MHz		_	0.6	1.7	dB
Maximum VSWR			VSWR				
@ TX port	832.34 861.66	MHz		_	1.6	2.0	
@ ANT port	832.34 861.66	MHz		_	1.7	2.0	
Maximum error vector magnitude			EVM _{max} ²⁾				
	834.4 859.6	MHz		_	2.1	4.0	%
	834.4 859.6	MHz		_	2.1	3.0 ³⁾	%
Minimum attenuation			$\alpha_{_{min}}$				
	10 771	MHz		35	44	—	dB
	771 791	MHz		40	47	—	dB
	791 821	MHz		50	60	—	dB
	821 827	MHz		1.5	7	—	dB
	873 903	MHz		5	29	—	dB
	925 960	MHz		35	45	—	dB
	1565 1606	MHz		45	52	—	dB
	1664 2170	MHz		45	55	—	dB
	2400 2483	MHz		50	57	—	dB
	2496 2586	MHz		50	57	—	dB
	2620 2690	MHz		45	57	—	dB
	3328 3448	MHz		30	44	—	dB
	4000 6000	MHz		20	30	—	dB

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.

³⁾ At 25°C.

6.2 ANT – RX

Temperature range for specification	T _{SPEC}	= −20 °C +90 °C
TX terminating impedance	Z _{TX}	= 50 Ω with ser. 4.7 nH ¹⁾
ANT terminating impedance	Z	= 50 Ω with par. 11 nH ¹⁾
RX terminating impedance	Z _{RX}	= 50 Ω

Characteristics ANT – RX				min. for $T_{_{\rm SPEC}}$	typ. @ +25 °C	max. for $T_{\rm SPEC}$	
Center frequency			f _c	—	806	—	MHz
Maximum insertion attenuation			$\alpha_{_{max}}$				
	791.34 820.66	MHz		_	1.6	2.5	dB
Amplitude ripple (p-p)			Δα				
	791.34 820.66	MHz		—	0.6	1.7	dB
Maximum VSWR			$VSWR_{max}$				
@ ANT port	791.34 820.66	MHz		—	1.7	2.0	
@ RX port	791.34 820.66	MHz		—	1.9	2.2	
Minimum attenuation			$\alpha_{_{min}}$				
	10 771	MHz		40	45	—	dB
	771 782	MHz		10	26	—	dB
	832 862	MHz		50	60	—	dB
	873 903	MHz		40	56	—	dB
	1623 1683	MHz		40	47	—	dB
	2373 2570	MHz		40	45	—	dB
	4900 6000	MHz		13	16		dB

¹⁾ See Sec. Matching circuit (p. 6).

6.3 TX – RX

Temperature range for specification	$T_{_{\rm SPEC}}$	= −20 °C +90 °C
TX terminating impedance	Z_{TX}	= 50 Ω with ser. 4.7 nH ¹⁾
ANT terminating impedance	Z	= 50 Ω with par. 11 nH ¹⁾
RX terminating impedance	Z _{RX}	= 50 Ω

Characteristics TX – RX				min. for $T_{_{\rm SPEC}}$	typ. @ +25 °C	max. for $T_{\rm SPEC}$	
Minimum isolation			$\boldsymbol{\alpha}_{min}$				
	791.34 820.66	MHz		55	59	—	dB
	832.34 861.66	MHz		57	62	—	dB
	1574 1577	MHz		40	55	—	dB
	1664 1724	MHz		20	55	—	dB
	2496 2586	MHz		20	53	—	dB

¹⁾ See Sec. Matching circuit (p. 6).

7 Maximum ratings

Storage temperature	T _{STG} ¹⁾	
	−40 °C +85 °C	
	+125 °C (max.) ²⁾	
DC voltage	$ V_{\rm DC} ^{3} = 0 V \text{ (max.)}$	
ESD voltage		
	V _{ESD} ⁴⁾ = 300 V (max.)	Human body model.
	$V_{\rm ESD}^{5}$ = 600 V (max.)	Charged device model.
Input power	P _{IN}	
Outside @ TX port: 832 862 MHz	30 dBm	Continuous wave for 5000 h @ 50 °C.
Outside @ TX port: other frequency ranges	10 dBm	Continuous wave for 5000 h @ 50 °C.

¹⁾ Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

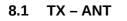
²⁾ 96h High Temperature Storage acc. to IEC 60068-2-2 Bd.

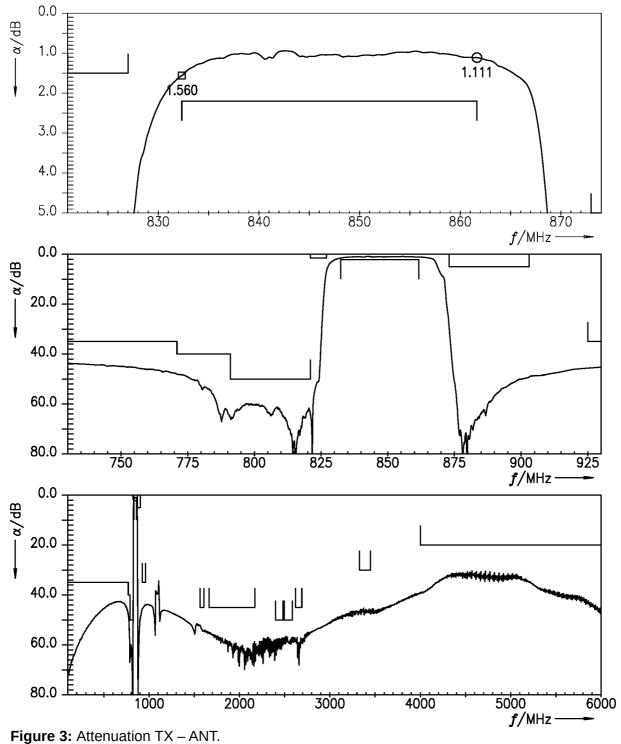
³⁾ In case of applied DC voltage blocking capacitors are mandatory.

⁴⁾ According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

⁵⁾ According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses.

8 Transmission coefficients





8.2 ANT – RX

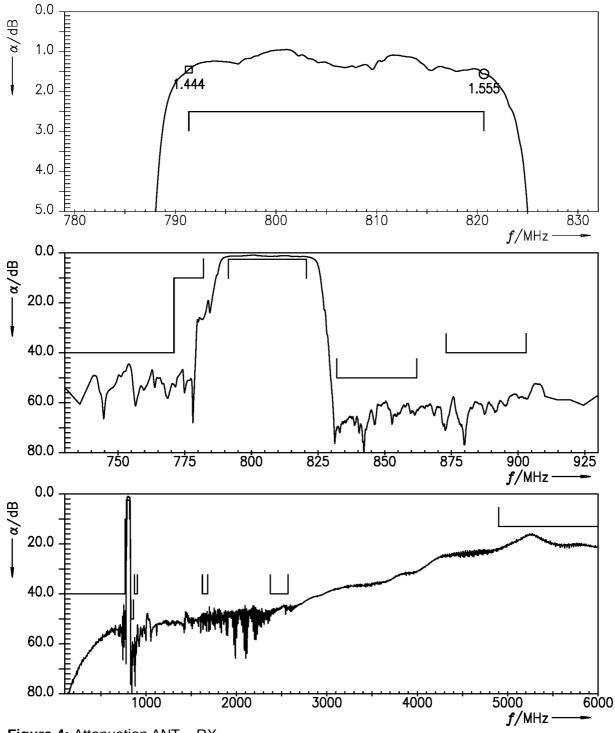


Figure 4: Attenuation ANT – RX.

Please read **Cautions and warnings** and **Important notes** at the end of this document.

8.3 TX – RX

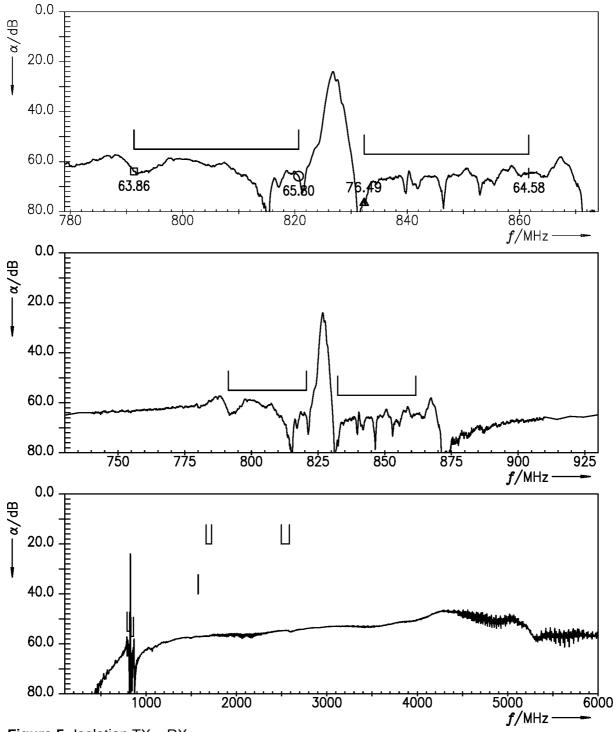


Figure 5: Isolation TX – RX.

Please read **Cautions and warnings** and **Important notes** at the end of this document.

□ = 832.3 O = 861.7

9 Reflection coefficients

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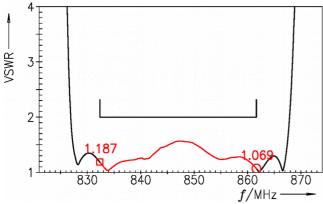


Figure 6: Reflection coefficient at TX port.

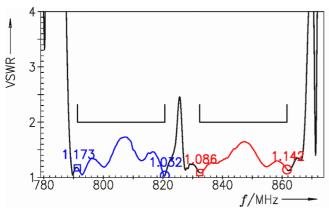


Figure 7: Reflection coefficient at ANT port.

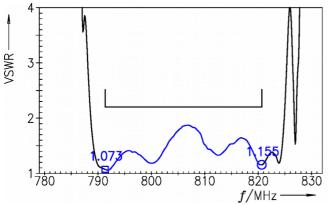
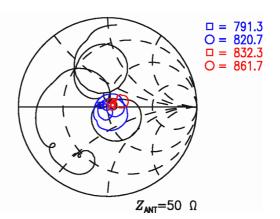
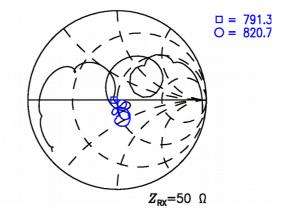


Figure 8: Reflection coefficient at RX port.



*Z*_{TX}=50 Ω





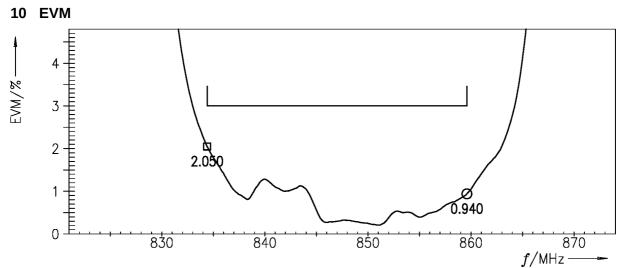
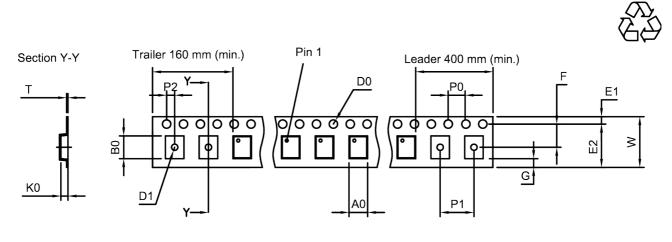


Figure 9: Error vector magnitude.



11 Packing material

11.1 Tape



User direction of unreeling

Figure 10: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	1.62±0.05 mm
B ₀	2.04±0.05 mm
D ₀	1.5+0.1/-0 mm
D ₁	0.8±0.05 mm
E1	1.75±0.1 mm

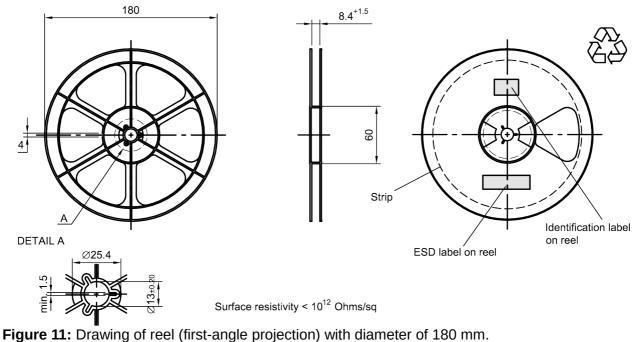
E ₂	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K ₀	0.62±0.05 mm
P ₀	4.0±0.1 mm

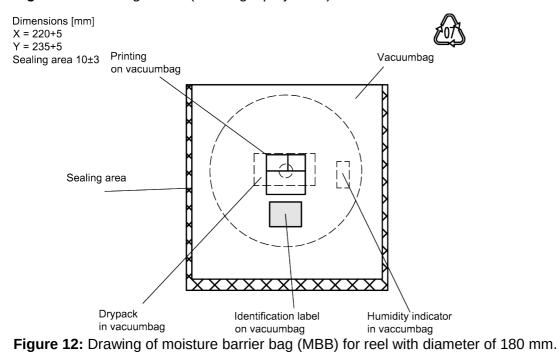
P ₁	4.0±0.1 mm
P ₂	2.0±0.05 mm
Т	0.25±0.05 mm
W	8.0±0.1 mm

Table 1: Tape dimensions.



11.2 Reel with diameter of 180 mm





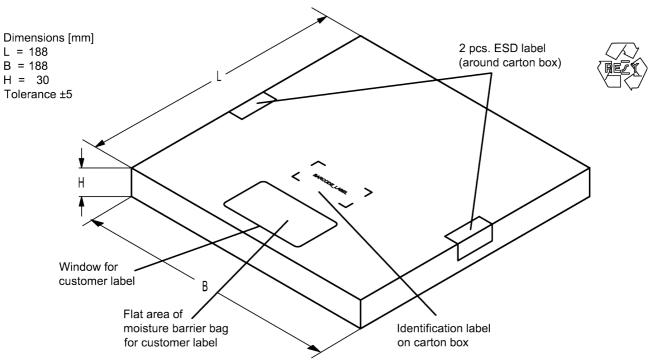


Figure 13: Drawing of folding box for reel with diameter of 180 mm.

11.3 Reel with diameter of 330 mm

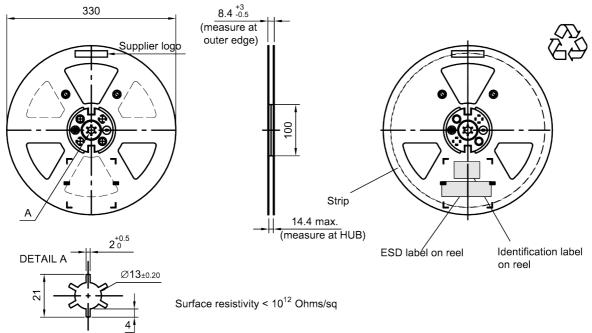


Figure 14: Drawing of reel (first-angle projection) with diameter of 330 mm.



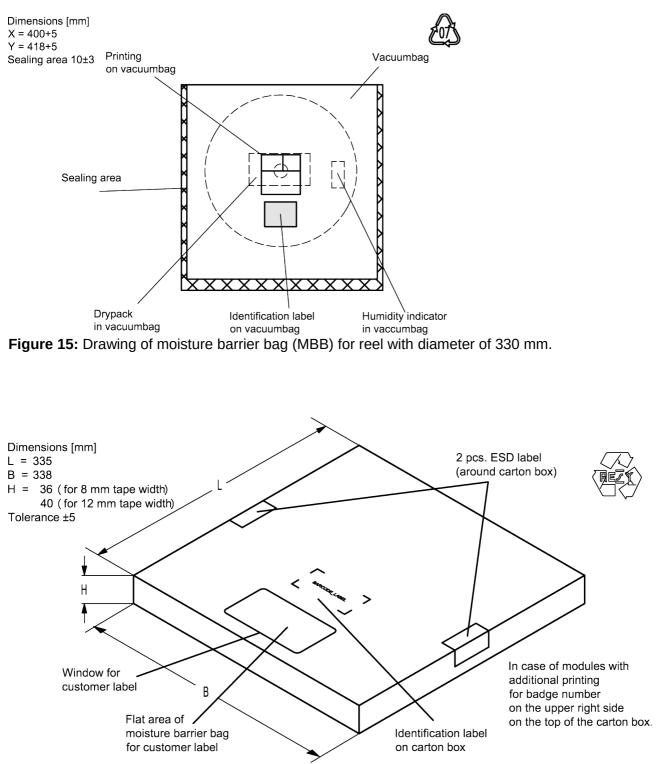


Figure 16: Drawing of folding box for reel with diameter of 330 mm.

12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number is encoded by a special	e.g., B3xxxxB <u>1234</u> xxxx,	
Example of decoding 16J	type number marking on device =>	in decimal code. 1234
1 x 32 ² + 6 x 32 ¹ + 18 (=J) x 32 ⁰ = The BASE32 code for product type B8671 is 8EZ.		1234

Lot number:

The last 5 digits of the lot number,e.g.,**12345**,are encoded based on a special BASE47 code into a 3 digit marking.12345,

Example of decoding lot number marking on device 5UY

	5	5	
5UY			=>
5 x 47 ²	+ 27 (=U) x 47 ¹ + 32	L (=Y) x 47°	=

Adopted BASE32 code for type number			
Decimal	Base32	Decimal	Base32
value	code	value	code
0	0	16	G
1	1	17	Н
2	2	18	J
3	3	19	K
4	4	20	М
5	5	21	N
6	6	22	Р
7	7	23	Q
8	8	24	R
9	9	25	S
10	А	26	Т
11	В	27	V
12	С	28	W
13	D	29	Х
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal	Base47	Decimal	Base47
value	code	value	code
0	0	24	R
1	1	25	S
2	2	26	Т
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	Х
7	7	31	Y
8	8	32	Z
9	9	33	b
10	Α	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	н	41	١
18	J	42	?
19	К	43	{
20	L	44	}
21	М	45	<
22	N	46	>
23	Р		

in decimal code. 12345

12345

Table 2: Lists for encoding and decoding of marking.

13 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3^{rd} edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
<i>T</i> > 220 °C	30 s to 70 s
<i>T</i> > 230 °C	min. 10 s
<i>T</i> > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

 Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

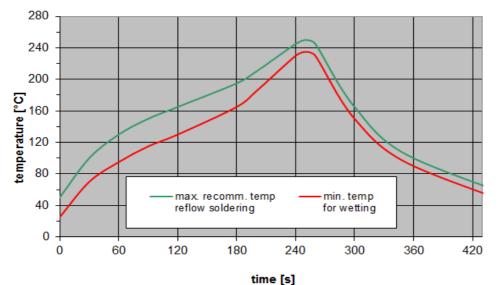


Figure 17: Recommended reflow profile for convection and infrared soldering – lead-free solder.

14 Annotations

14.1 Matching coils

See TDK inductor pdf-catalog <u>http://www.tdk.co.jp/tefe02/coil.htm#aname1</u> and Data Library for circuit simulation <u>http://www.tdk.co.jp/etvcl/index.htm</u>.

14.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

14.4 Ordering codes and packing units

Ordering code	Packing unit
B39851B8671P810	15000 pcs
B39851B8671P810S5	5000 pcs

Table 4: Ordering codes and packing units.

15 Cautions and warnings

15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.

16 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
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- 3. The warnings, cautions and product-specific notes must be observed.
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